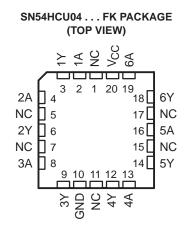
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- Wide Operating Voltage Range of 2 V to 6 V
- Outputs Can Drive Up To 10 LSTTL Loads
- Low Power Consumption, 20-μA Max I_{CC}

SN54HCU04 ... J OR W PACKAGE SN74HCU04 ... D, DB, N, NS, OR PW PACKAGE (TOP VIEW)

				_
1A [1	υ	14] v _{cc}
1Y [2			6A
2A [3		12] 6Y
2Y [4		11] 5A
ЗА [5		10] 5Y
3Y [6		9] 4A
GND [7		8] 4Y

- Typical t_{pd} = 7 ns
- ±4-mA Output Drive at 5 V
- Low Input Current of 1 μA Max
- Unbuffered Outputs



NC - No internal connection

description/ordering information

The 'HCU04 devices contain six independent inverters. They perform the Boolean function $Y = \overline{A}$ in positive logic.

TA	PACKA	GE†	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	PDIP – N	Tube of 25	SN74HCU04N	SN74HCU04N
		Tube of 50	SN74HCU04D	
-40°C to 85°C	SOIC – D	Reel of 2500	SN74HCU04DR	HCU04
		Reel of 250	SN74HCU04DT	
	SOP – NS	Reel of 2000	SN74HCU04NSR	HCU04
	SSOP – DB	Reel of 2000	SN74HCU04DBR	HU04
		Reel of 90	SN74HCU04PW	
	TSSOP – PW	Reel of 2000	SN74HCU04PWR	HCU04
		Reel of 250	SN74HCU04PWT	
	CDIP – J	Tube of 25	SNJ54HCU04J	SNJ54HCU04J
–55°C to 125°C	CFP – W	Tube of 150	SNJ54HCU04W	SNJ54HCU04W
	LCCC – FK	Tube of 55	SNJ54HCU04FK	SNJ54HCU04FK

ORDERING INFORMATION

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



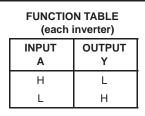
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logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

$\begin{array}{c} \mbox{Input clamp current, } I_{IK} (V_I < 0 \mbox{ or } V_I > V_{CC}) \ (see \ Note \ 1) \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ $	mA mA C/W C/W C/W C/W C/W
PW package 113°0 Storage temperature range, T _{stg} –65°C to 15	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 3)

			SN	154HCU)4	SN	I74HCUC)4	
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage		2	5	6	2	5	6	V
		$V_{CC} = 2 V$	1.7			1.7			
VIH	High-level input voltage	$V_{CC} = 4.5 V$	3.6			3.6			V
		VCC = 6 V	4.8			4.8			
		$V_{CC} = 2 V$			0.5			0.5	
VIL	Low-level input voltage	$V_{CC} = 4.5 V$			1.35			1.35	V
		VCC = 6 V			1.8			1.8	
VI	Input voltage		0		VCC	0		VCC	V
VO	Output voltage		0		VCC	0		VCC	V
Τ _Α	Operating free-air temperature		-55		125	-40		85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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				Τį	λ = 25°C	;	SN54H	CU04	SN74HCU04		UNIT
PARAMETER	TEST CON	DITIONS	Vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
			2 V	1.8			1.8		1.8		
		l _{OH} = -20 μA	4.5 V	4			4		4		
∨он	$V_I = V_{CC}$ or GND		6 V	5.5			5.5		5.5		V
		$I_{OH} = -4 \text{ mA}$	4.5 V	3.98			3.7		3.84		
		I _{OH} = -5.2 mA	6 V	5.48			5.2		5.34		
		l _{OL} = 20 μA	2 V			0.2		0.2		0.2	
			4.5 V			0.5		0.5		0.5	
VOL	$V_{I} = V_{CC} \text{ or } GND$		6 V			0.5		0.5		0.5	V
		$I_{OL} = 4 \text{ mA}$	4.5 V			0.26		0.4		0.33	
			6 V			0.26		0.4		0.33	
lj	VI = ACC or 0		6 V			±100		±1000		±1000	nA
ICC	$V_I = V_{CC} \text{ or } 0,$	IO = 0	6 V			2		40		20	μΑ
Ci			2 V to 6 V		3	10		10		10	pF

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

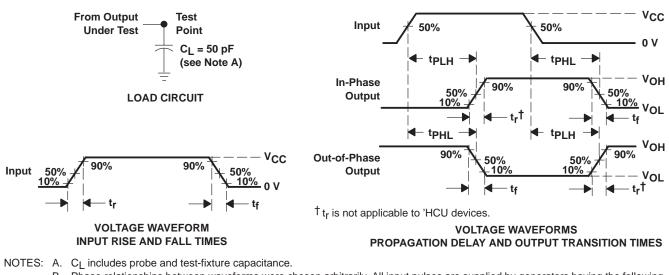
DADAMETED	PARAMETER FROM TO		N	T _A = 25°C			SN54HCU04		SN74HCU04		
PARAMETER	(INPUT)	(OUTPUT)	vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
			2 V		40	80		120		100	
^t pd	А	Y	4.5 V		8	16		24		20	ns
			6 V		7	14		20		17	
			2 V		38	75		110		95	
tf		Y	4.5 V		8	15		22		19	ns
			6 V		6	13		19		16	

operating characteristics, $T_A = 25^{\circ}C$

	PARAMETER	TEST CONDITIONS	TYP	UNIT
Cp	Power dissipation capacitance per inverter	No load	20	pF



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PARAMETER MEASUREMENT INFORMATION

- B. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_O = 50 Ω , t_f = 6 ns, t_f = 6 ns.
- C. The outputs are measured one at a time, with one input transition per measurement.
- D. t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 1. Load Circuit and Voltage Waveforms



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PACKAGING INFORMATION

TEXAS INSTRUMENTS www.ti.com

Be010012A ACTIVE LCCC FK 20 1 TBD POSTFLATE N/A for Pkg Type 8801001CA ACTIVE CDIP J 14 1 TBD A42 SNPB N/A for Pkg Type SN74HCU04J ACTIVE CDIP J 14 1 TBD A42 SNPB N/A for Pkg Type SN74HCU04D ACTIVE SOIC D 14 60 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM SN74HCU04DBR ACTIVE SSOP DB 14 2000 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM SN74HCU04DBR64 ACTIVE SSOP DB 14 2000 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM SN74HCU04DE4 ACTIVE SOIC D 14 50 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM SN74HCU04DR4 ACTIVE SOIC D 14 200 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM SN74HCU04DR4 ACTIVE SOIC D 14 250 Green (RoHS & CU NIPDAU	Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN64HCU04J ACTIVE CDIP J 14 1 TBD A42 SNP8 N / A for Pkg Type SN74HCU04D ACTIVE SOIC D 14 50 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM SN74HCU04DBR ACTIVE SSOP DB 14 2000 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM SN74HCU04DBRE4 ACTIVE SSOP DB 14 2000 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM SN74HCU04DBRG4 ACTIVE SSOP DB 14 2000 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM SN74HCU04DBG4 ACTIVE SOIC D 14 60 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM SN74HCU04DR ACTIVE SOIC D 14 2500 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM SN74HCU04DR4 ACTIVE SOIC D 14 2500 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM SN74HCU04DR64 ACTIVE SOIC D 14 2500 Green (RoHS & CU NI	86010012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SN74HCU04DD ACTIVE SOIC D 14 50 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM on Sb/Br) SN74HCU04DBR ACTIVE SSOP DB 14 2000 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM no Sb/Br) SN74HCU04DBRE4 ACTIVE SSOP DB 14 2000 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM no Sb/Br) SN74HCU04DBRG4 ACTIVE SSOP DB 14 2000 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM no Sb/Br) SN74HCU04DBRG4 ACTIVE SOIC D 14 50 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM no Sb/Br) SN74HCU04DR ACTIVE SOIC D 14 50 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM no Sb/Br) SN74HCU04DR ACTIVE SOIC D 14 2500 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM no Sb/Br) SN74HCU04DRE4 ACTIVE SOIC D 14 2500 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM no Sb/Br) SN74HCU04DTE4 ACTIVE SOIC D	8601001CA	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
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Ino SbiBr) SN74HCU04DE4 ACTIVE SOIC D 14 50 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM no SbiBr) SN74HCU04DG4 ACTIVE SOIC D 14 50 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM no SbiBr) SN74HCU04DR ACTIVE SOIC D 14 2500 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM no SbiBr) SN74HCU04DRE4 ACTIVE SOIC D 14 2500 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM no SbiBr) SN74HCU04DRE4 ACTIVE SOIC D 14 2500 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM no SbiBr) SN74HCU04DT ACTIVE SOIC D 14 250 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM no SbiBr) SN74HCU04DT ACTIVE SOIC D 14 250 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM no SbiBr) SN74HCU04DT64 ACTIVE SOIC D 14 250 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM no SbiBr) SN74HCU04NN ACTIVE <td>SN74HCU04DBRE4</td> <td>ACTIVE</td> <td>SSOP</td> <td>DB</td> <td>14</td> <td>2000</td> <td>,</td> <td>CU NIPDAU</td> <td>Level-1-260C-UNLIM</td>	SN74HCU04DBRE4	ACTIVE	SSOP	DB	14	2000	,	CU NIPDAU	Level-1-260C-UNLIM
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No.No	SN74HCU04DRE4	ACTIVE	SOIC	D	14	2500	,	CU NIPDAU	Level-1-260C-UNLIM
N74HCU04DTE4ACTIVESOICD14250Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04DTG4ACTIVESOICD14250Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04NACTIVEPDIPN1425Pb-Free (RoHS)CU NIPDAUN / A for Pkg Type (RoHS)SN74HCU04N3OBSOLETEPDIPN1425Pb-Free (RoHS)CU NIPDAUN / A for Pkg Type (ROHS)SN74HCU04N84ACTIVEPDIPN1425Pb-Free (ROHS)CU NIPDAUN / A for Pkg Type (ROHS)SN74HCU04NSRACTIVESONS142000Green (RoHS & (ROHS)CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04NSRE4ACTIVESONS142000Green (RoHS & (ROHS & (CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04NSR64ACTIVESONS142000Green (RoHS & (CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWACTIVETSSOPPW1490Green (RoHS & (CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWE4ACTIVETSSOPPW1490Green (RoHS & (CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWRE4ACTIVETSSOPPW1490Green (RoHS & (ROHS & (CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWRE4ACTIVETSSOPPW1490Green (RoHS & (ROHS & (CU NIP	SN74HCU04DRG4	ACTIVE	SOIC	D	14	2500	,	CU NIPDAU	Level-1-260C-UNLIM
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N74HCU04NACTIVEPDIPN1425Pb-Free (RoHS)CU NIPDAUN / A for Pkg TypeSN74HCU04N3OBSOLETEPDIPN14TBDCall TICall TICall TISN74HCU04NE4ACTIVEPDIPN1425Pb-Free (RoHS)CU NIPDAUN / A for Pkg TypeSN74HCU04NSRACTIVESONS142000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04NSRE4ACTIVESONS142000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04NSRE4ACTIVESONS142000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04NSRG4ACTIVESONS142000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWACTIVETSSOPPW1490Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWE4ACTIVETSSOPPW1490Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWR4ACTIVETSSOPPW1490Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWRACTIVETSSOPPW1490Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWR4ACTIVETSSOPPW142000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWR4ACTIVETSSOPPW142000	SN74HCU04DTE4	ACTIVE	SOIC	D	14	250	,	CU NIPDAU	Level-1-260C-UNLIM
SN74HCU04N3OBSOLETEPDIPN14TBDCall TICall TISN74HCU04NE4ACTIVEPDIPN1425Pb-Free (RoHS)CU NIPDAUN / A for Pkg TypeSN74HCU04NSRACTIVESONS142000Green (RoHS & or Sb/Br)CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04NSRE4ACTIVESONS142000Green (RoHS & cU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04NSRE4ACTIVESONS142000Green (RoHS & cU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04NSRG4ACTIVESONS142000Green (RoHS & cU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWACTIVETSSOPPW1490Green (RoHS & cU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWG4ACTIVETSSOPPW1490Green (RoHS & cu NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWRACTIVETSSOPPW1490Green (RoHS & cu NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWRACTIVETSSOPPW142000Green (RoHS & cu NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWRACTIVETSSOPPW142000Green (RoHS & cu NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWRE4ACTIVETSSOPPW142000Green (RoHS & cu NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWRE4ACT	SN74HCU04DTG4	ACTIVE	SOIC	D	14	250		CU NIPDAU	Level-1-260C-UNLIM
SN74HCU04NE4ACTIVEPDIPN1425Pb-Free (RoHS)CU NIPDAUN / A for Pkg TypeSN74HCU04NSRACTIVESONS142000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM Level-1-260C-UNLIM no Sb/Br)SN74HCU04NSRE4ACTIVESONS142000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM Level-1-260C-UNLIM no Sb/Br)SN74HCU04NSRE4ACTIVESONS142000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM Level-1-260C-UNLIM no Sb/Br)SN74HCU04PWACTIVETSSOPPW1490Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWE4ACTIVETSSOPPW1490Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWG4ACTIVETSSOPPW1490Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWRACTIVETSSOPPW142000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWRACTIVETSSOPPW142000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWRE4ACTIVETSSOPPW142000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM no Sb/Br)	SN74HCU04N	ACTIVE	PDIP	Ν	14	25		CU NIPDAU	N / A for Pkg Type
(RoHS)(RoHS)SN74HCU04NSRACTIVESONS142000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04NSRE4ACTIVESONS142000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04NSRG4ACTIVESONS142000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWACTIVETSSOPPW142000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWE4ACTIVETSSOPPW1490Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWG4ACTIVETSSOPPW1490Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWR4ACTIVETSSOPPW1490Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWR4ACTIVETSSOPPW1490Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWR4ACTIVETSSOPPW142000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)<	SN74HCU04N3	OBSOLETE	PDIP	Ν	14		TBD	Call TI	Call TI
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N74HCU04NSRG4ACTIVESONS142000Green (RoHS & CU NIPDAULevel-1-260C-UNLIMSN74HCU04PWACTIVETSSOPPW1490Green (RoHS & CU NIPDAULevel-1-260C-UNLIMSN74HCU04PWE4ACTIVETSSOPPW1490Green (RoHS & CU NIPDAULevel-1-260C-UNLIMSN74HCU04PWE4ACTIVETSSOPPW1490Green (RoHS & CU NIPDAULevel-1-260C-UNLIMSN74HCU04PWG4ACTIVETSSOPPW1490Green (RoHS & CU NIPDAULevel-1-260C-UNLIMSN74HCU04PWRACTIVETSSOPPW142000Green (RoHS & CU NIPDAULevel-1-260C-UNLIMSN74HCU04PWRE4ACTIVETSSOPPW142000Green (RoHS & CU NIPDAULevel-1-260C-UNLIMSN74HCU04PWRE4ACTIVETSSOPPW142000Green (RoHS & CU NIPDAULevel-1-260C-UNLIMSN74HCU04PWRE4ACTIVETSSOPPW142000Green (RoHS & CU NIPDAULevel-1-260C-UNLIMSN74HCU04PWRE4ACTIVETSSOPPW142000Green (RoHS & CU NIPDAULevel-1-260C-UNLIMNoSh/Br)Sh/Br)Sh/Br)Sh/Br)Sh/Br)Sh/Br)Sh/Br)Sh/Br)	SN74HCU04NSR	ACTIVE	SO	NS	14	2000		CU NIPDAU	Level-1-260C-UNLIM
N74HCU04PWACTIVETSSOPPW1490Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWE4ACTIVETSSOPPW1490Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWG4ACTIVETSSOPPW1490Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWG4ACTIVETSSOPPW1490Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWRACTIVETSSOPPW142000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWRE4ACTIVETSSOPPW142000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWRE4ACTIVETSSOPPW142000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)	SN74HCU04NSRE4	ACTIVE	SO	NS	14	2000	,	CU NIPDAU	Level-1-260C-UNLIM
N74HCU04PWE4ACTIVETSSOPPW1490Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIMSN74HCU04PWG4ACTIVETSSOPPW1490Green (RoHS & CU NIPDAULevel-1-260C-UNLIMSN74HCU04PWRACTIVETSSOPPW142000Green (RoHS & CU NIPDAULevel-1-260C-UNLIMSN74HCU04PWRACTIVETSSOPPW142000Green (RoHS & CU NIPDAULevel-1-260C-UNLIMSN74HCU04PWRE4ACTIVETSSOPPW142000Green (RoHS & CU NIPDAULevel-1-260C-UNLIMSN74HCU04PWRE4ACTIVETSSOPPW142000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM	SN74HCU04NSRG4	ACTIVE	SO	NS	14	2000	`	CU NIPDAU	Level-1-260C-UNLIM
SN74HCU04PWE4ACTIVETSSOPPW1490Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWG4ACTIVETSSOPPW1490Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWRACTIVETSSOPPW142000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWRE4ACTIVETSSOPPW142000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)SN74HCU04PWRE4ACTIVETSSOPPW142000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)	SN74HCU04PW	ACTIVE	TSSOP	PW	14	90		CU NIPDAU	Level-1-260C-UNLIM
SN74HCU04PWG4 ACTIVE TSSOP PW 14 90 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM no Sb/Br) SN74HCU04PWR ACTIVE TSSOP PW 14 2000 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM no Sb/Br) SN74HCU04PWR ACTIVE TSSOP PW 14 2000 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM no Sb/Br) SN74HCU04PWRE4 ACTIVE TSSOP PW 14 2000 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM no Sb/Br)	SN74HCU04PWE4	ACTIVE	TSSOP	PW	14	90	Green (RoHS &	CU NIPDAU	Level-1-260C-UNLIM
SN74HCU04PWR ACTIVE TSSOP PW 14 2000 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM no Sb/Br) SN74HCU04PWRE4 ACTIVE TSSOP PW 14 2000 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM no Sb/Br)	SN74HCU04PWG4	ACTIVE	TSSOP	PW	14	90		CU NIPDAU	Level-1-260C-UNLIM
SN74HCU04PWRE4 ACTIVE TSSOP PW 14 2000 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM no Sb/Br)	SN74HCU04PWR	ACTIVE	TSSOP	PW	14	2000	Green (RoHS &	CU NIPDAU	Level-1-260C-UNLIM
SN74HCU04PWRG4 ACTIVE TSSOP PW 14 2000 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM	SN74HCU04PWRE4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS &	CU NIPDAU	Level-1-260C-UNLIM
	SN74HCU04PWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS &	CU NIPDAU	Level-1-260C-UNLIM

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Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
						no Sb/Br)		
SN74HCU04PWT	ACTIVE	TSSOP	PW	14	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HCU04PWTE4	ACTIVE	TSSOP	PW	14	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HCU04PWTG4	ACTIVE	TSSOP	PW	14	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SNJ54HCU04FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54HCU04J	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

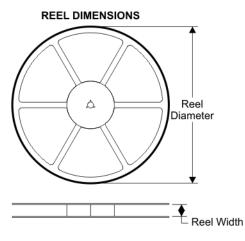
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

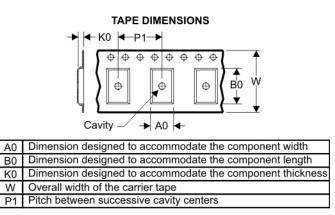
⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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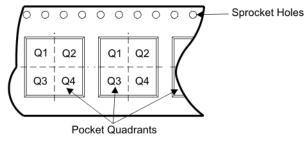
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TAPE AND REEL BOX INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



Device	Package	Pins	Site	Reel Diameter (mm)	Reel Width (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74HCU04DBR	DB	14	SITE 41	330	16	8.2	6.6	2.5	12	16	Q1
SN74HCU04DR	D	14	SITE 27	330	16	6.5	9.0	2.1	8	16	Q1
SN74HCU04DR	D	14	SITE 41	330	16	6.5	9.0	2.1	8	16	Q1
SN74HCU04NSR	NS	14	SITE 41	330	16	8.2	10.5	2.5	12	16	Q1
SN74HCU04PWR	PW	14	SITE 41	330	12	7.0	5.6	1.6	8	12	Q1



PACKAGE MATERIALS INFORMATION

22-Sep-2007



Device	Package	Pins	Site	Length (mm)	Width (mm)	Height (mm)
SN74HCU04DBR	DB	14	SITE 41	346.0	346.0	0.0
SN74HCU04DR	D	14	SITE 27	342.9	336.6	0.0
SN74HCU04DR	D	14	SITE 41	346.0	346.0	0.0
SN74HCU04NSR	NS	14	SITE 41	346.0	346.0	0.0
SN74HCU04PWR	PW	14	SITE 41	346.0	346.0	0.0

J (R-GDIP-T**) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

MLCC006B - OCTOBER 1996

FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G14)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.

Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.

E. Reference JEDEC MS-012 variation AB.



MECHANICAL DATA

PLASTIC SMALL-OUTLINE PACKAGE

0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 \bigcirc Gage Plane ₽ 0,25 7 1 1,05 0,55 0°-10° Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS ** 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G**)

14-PINS SHOWN

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



MECHANICAL DATA

MSSO002E - JANUARY 1995 - REVISED DECEMBER 2001

DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-150



MECHANICAL DATA

MTSS001C - JANUARY 1995 - REVISED FEBRUARY 1999

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153

